ASSOCIATION CONNEC	Material Compo © Copyright 2005. IF international and Pan	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
1752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute					* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Materi					ials and Mfg Information			
Supplier Info	rmation						·								
Company name*		Company unique ID			ī	Unique ID Authority					Response Date*				
onsemi											20	2023-06-08			
Contact Name		Title - Contact			]	Phone - Contact*				Eı	Email - Contact*				
Product-Env-Ste	wards		Product Enviro Compliance				NA				P	Product-Env-Stewards@onsemi.com			
uthorized Repr	esentative*	Title - Representative			1	Phone - Representative*				Eı	Email - Representative*				
Product-Env-Ste	ewards	Product Enviro Compliance				NA				P	Product-Env-Stewards@onsemi.com				
Reque	Requester Item Number M		Mfr Item Number Mfr Item Name				Effective Dat	e Vers	ion	Manufacturing Site		Weight*	UOM	Unit Type	
		NCP161	NCP161AFCT285T2G CSP LDO 450mA, Act		, Active Discl	harge	2023-06-08			CNQ		0.2662	mg	Each	
Ianufacturin	ng Proccess Informat	tion													
Terminal Plating / Grid Array Material			Terminal Base Alloy J-STD-020 MSI		SL Rating	Peak Process Body Temperature Max Tir		ire Max Time a	t Peak Ter	mperature Nur	mber of Reflow Cy	cles			
Matte Tin (Sn) - annealed			CU Alloy 1			260 C 30			seconds 3						
omments															
vel 1 - maximur	n time at peak temperatu	re during sol	dering is 10-3	0 seconds											
or more inform	ation regarding material o	composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Bump	0.02444	mg	Supplier	Tin (Sn)	7440-31-5		0.0244	mg
Die	0.21966	mg	Supplier	Silicon (Si)	7440-21-3		0.2197	mg
Protection coat	0.0059	mg		Polyimide	proprietary data		0.0059	mg
RDL Sputter	4.3E-4	mg	Supplier	Titanium (Ti)	7440-32-6		0	mg
			Supplier	Copper (Cu)	7440-50-8		0.0004	mg
UBM/RDL PCu	0.01527	mg	Supplier	Copper (Cu)	7440-50-8		0.0153	mg
UBM Sputter	5.0E-4	mg	Supplier	Titanium (Ti)	7440-32-6		0.0001	mg
			Supplier	Copper (Cu)	7440-50-8		0.0004	mg